

DOCKET NO: 221608US0PCT



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :  
MINORU TAKAYA, ET AL. : EXAMINER: JOHNSON, J. J.  
SERIAL NO: 10/089,067 :  
FILED: APRIL 5, 2002 : GROUP ART UNIT: 1725  
FOR: SOLDERING FLUX, SOLDER :  
PASTE AND METHOD OF SOLDERING :

AMENDMENT

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Responsive to the Office Action dated June 3, 2004, Applicants respectfully request reconsideration of the above-identified application in view of the following amendment and remarks.

**Amendments to the Specification** begins on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Discussion of the Amendment** begins on page 19 of this paper.

**Remarks** begin on page 20 of this paper.

12/01/2004 FNETKI1 00000045 10089067

01 FC:1201	616.00 OP
02 FC:1202	198.00 OP